



Issue date: July 15, 2024

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ROHM Co., Ltd.

Notification of Product/Process Change
Doc. No.: 222400B

This letter intends as a formal notification of change to products which are currently supplied by ROHM Co., Ltd.

ROHM Co., Ltd. requires customers to provide acknowledgment of the receipt of this notification within 30 days from the date of this notice. Lack of acknowledgment of this notice within 30 days is considered as acceptance of the change.

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.

Your understanding and cooperation would be highly appreciated.

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Title of change	Application for change due to discontinuation of wafer coating (polyimide) (IGBT)	
Affected product(s)	Manufacturer part number	Customer part number
	Refer to the attached document.	
Detailed description of change	Before	After
	Wafer coating : conventional polyimide	Wafer coating : new polyimide
Reason for change	The polyimide material used for wafer coating will be discontinued, and will be replaced by an alternative material for continued supply.	
Anticipated impact on quality	Result of evaluations, we confirmed that there is no difference in reliability.	
Identification of change	This can be identified by checking the production history from the lot information.	
Planned first ship date	April 1, 2025	
Qualification plan schedule, results and samples	If required, please contact the local ROHM sales office or the authorized distributor.	
Comments	Samples will be available after August 2024 with a lead time of 1.5 months from request.	
Supplier contact	Please contact the local ROHM sales office or the authorized distributor.	
Notes		